



February 16, 2006

To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/802,563 03/17/04

Hong Yu Yu et al

“A THERMAL ROBUST SEMICONDUCTOR  
DEVICE USING HFN AS METAL GATE  
ELECTRODE AND THE MANUFACTURING  
PROCESS THEREOF”

Grp. Art Unit: 2823

SU C. KIM

## RESPONSE FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Final Office Action dated November 23, 2005, please consider the following remarks concerning the above-identified application for patent:

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 16, 2006.

Rosemary L. S. Pike, Reg # 39,332

Signature Rosemary L. S. PikeDate February 16, 2006